



#### P-CHANNEL ENHANCEMENT MODE MOSFET

#### **Product Summary**

| BV <sub>DSS</sub> | Rds(on) MAX        | I <sub>D</sub> MAX<br>T <sub>A</sub> = +25°C |
|-------------------|--------------------|--|
| -30V              | 19mΩ @ Vgs = -10V  | -8.7A  |
| -30 V             | 45mΩ @ VGS = -4.5V | -5.5A  |

### **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- Battery Management Application
- Power Management Functions
- DC-DC Converters

#### **Features and Benefits**

- 0.6mm Profile Ideal for Low Profile Applications
- Low Gate Threshold Voltage
- Low On-Resistance
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

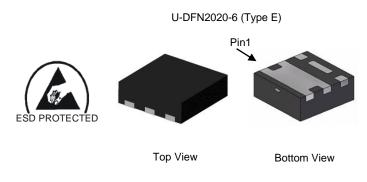
https://www.diodes.com/products/automotive/automotive-products/.

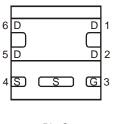
 This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.

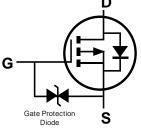
https://www.diodes.com/quality/product-definitions/

#### **Mechanical Data**

- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.007 grams (Approximate)







**Equivalent Circuit** 

Pin Out Bottom View

### Ordering Information (Note 4)

| Part Number    | Case                 | Packaging          |
|----------------|----------------------|--------------------|
| DMP3026SFDE-7  | U-DFN2020-6 (Type E) | 3,000/Tape & Reel  |
| DMP3026SFDE-13 | U-DFN2020-6 (Type E) | 10,000/Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



## **Marking Information**

Site 1



7P = Product Type Marking Code YM = Date Code Marking Y = Year (ex: H = 2020) M = Month (ex: 9 = September)

Date Code Kev

| Date Code Ney |      |        |      |        |      |      |      |        |      |      |      |      |
|---------------|------|--------|------|--------|------|------|------|--------|------|------|------|------|
| Year          | 2016 |        | 2020 | 2021   | 2022 | 2023 | 2024 | 2025   | 2026 | 2027 | 2028 | 2029 |
| Code          | D    |        | Н    | ı      | J    | K    | L    | М      | N    | 0    | Р    | R    |
|               |      |        |      |        |      |      |      |        |      |      |      |      |
|               | 1    | l<br>I |      | l<br>I | I .  |      |      | l<br>I |      |      |      | I.   |
| Month         | Jan  | Feb    | Mar  | Apr    | May  | Jun  | Jul  | Aug    | Sep  | Oct  | Nov  | Dec  |

Site 2



7P = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 0 = 2020) W = Week (ex: a = Week 27; z Represents Week 52 and 53) X = Internal Code (ex: U = Monday)

Date Code Key

| Year | 2016 | <br>2020 | 2021 | 2022 | 2023 | 2024 | 2025 | 2026 | 2027 | 2028 | 2029 |
|------|------|----------|------|------|------|------|------|------|------|------|------|
| Code | 6    | <br>0    | 1    | 2    | 3    | 4    | 5    | 6    | 7    | 8    | 9    |

| Week | 1-26 | 27-52 | 53 |
|------|------|-------|----|
| Code | A-Z  | a-z   | Z  |

| Internal Code | Sun | Mon | Tue | Wed | Thu | Fri | Sat |
|---------------|-----|-----|-----|-----|-----|-----|-----|
| Code          | Т   | U   | V   | W   | X   | Υ   | Z   |



#### **Maximum Ratings** (@TA = +25°C, unless otherwise specified.)

| Characteristic  | Symbol | Value  | Unit             |               |    |
|---|--------|--|------------------|---------------|----|
| Drain-Source Voltage  | VDSS   | -30  | V                |               |    |
| Gate-Source Voltage   |        |  | V <sub>GSS</sub> | ±25           | V  |
| Stea Stat   |        | T <sub>A</sub> = +25°C<br>T <sub>A</sub> = +70°C | lo               | -8.7<br>-6.9  | А  |
| Continuous Drain Current (Note 6) V <sub>GS</sub> = -10V        | t<10s  | $T_A = +25^{\circ}C$<br>$T_A = +70^{\circ}C$     | lo               | -10.4<br>-8.4 | А  |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%               | )      |  | I <sub>DM</sub>  | -50           | Α  |
| Continuous Source-Drain Diode Current (Note 6) T <sub>A</sub> = |        |  | Is               | -2.0          | Α  |
| Avalanche Current (Note 7) L = 0.1mH                            | las    | -23  | Α                |               |    |
| Avalanche Energy (Note 7) L = 0.1mH                             |        |  | E <sub>AS</sub>  | 27            | mJ |

# Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

| Characteristic                                   | Symbol                 | Value             | Unit        |      |  |
|--|------------------------|-------------------|-------------|------|--|
| Total Power Dissipation (Note 5)                 | T <sub>A</sub> = +25°C | D-                | 0.72        | W    |  |
| Total Power Dissipation (Note 5)                 | $T_A = +70^{\circ}C$   | PD                | 0.46        | VV   |  |
| Thermal Resistance, Junction to Ambient (Note 5) | Steady State           | ρ                 | 175         | °C/W |  |
| Thermal Resistance, Junction to Ambient (Note 5) | t<10s                  | $R_{\theta JA}$   | 121         | C/VV |  |
| Total Power Dissipation (Note 6)                 | $T_A = +25$ °C         | D-                | 2.0         | W    |  |
| Total Fower Dissipation (Note o)                 | $T_A = +70$ °C         | PD                | 1.3         |      |  |
| Thermal Decistores, Junction to Ambient (Note 6) | Steady State           | Б.                | 61          |      |  |
| Thermal Resistance, Junction to Ambient (Note 6) | t<10s                  | RθJA              | 42          | °C/W |  |
| Thermal Resistance, Junction to Case (Note 6)    | Steady State           | R <sub>θ</sub> JC | 9.3         |      |  |
| Operating and Storage Temperature Range          |                        | ТJ, Tsтg          | -55 to +150 | °C   |  |

## **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic   | Symbol              | Min | Тур   | Max  | Unit                                      | Test Condition                              |
|--|---------------------|-----|-------|------|---|---|
| OFF CHARACTERISTICS (Note 8)                           |                     |     |       |      |   |   |
| Drain-Source Breakdown Voltage                         | BVDSS               | -30 | _     | _    | V   | $Vgs = 0V, ID = -250\mu A$                  |
| Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C |                     | _   | _     | -1   |   | \/ 24\/ \/ 0\/                              |
| Zero Gate Voltage Drain Current TJ = +150°C (Note 9)   | I <sub>DSS</sub>    | -   | _     | -100 | μA  | VDS = -24V, $VGS = 0V$                      |
| Gate-Source Leakage                                    | Igss                | _   | _     | ±10  | μΑ  | Vgs = ±25V, Vps = 0V                        |
| ON CHARACTERISTICS (Note 8)                            |                     |     |       |      |   | <u>.</u>                                    |
| Gate Threshold Voltage                                 | Vgs(TH)             | -1  | _     | -3   | V   | $V_{DS} = V_{GS}$ , $I_D = -250\mu A$       |
| 1  |                     |     | 15    | 19   |   | Vgs = -10V, ID = -4.5A                      |
| Static Drain-Source On-Resistance                      | RDS(ON)             | _   | 28    | 45   | mΩ  | Vgs = -4.5V, ID = -3.5A                     |
| <u></u> !  | <u> </u>            |     | 34    | 54   | <u></u>                                   | Vgs = -4.0V, ID = -3.0A                     |
| Diode Forward Voltage                                  | VsD                 | _   | -0.7  | -1.2 | V   | Vgs = 0V, Is = -1.0A                        |
| DYNAMIC CHARACTERISTICS (Note 9)                       |                     |     |       |      |   |   |
| Input Capacitance                                      | Ciss                | _   | 1,204 | _    |   | 451/1/ 01/                                  |
| Output Capacitance                                     | Coss                | _   | 154   | _    | pF  | $V_{DS} = -15V, V_{GS} = 0V,$<br>f = 1.0MHz |
| Reverse Transfer Capacitance                           | C <sub>rss</sub>    |     | 112   | _    |   | = 1.0 V    2                                |
| Gate Resistance  | Rg                  | _   | 16    | _    | Ω   | $V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$  |
| Total Gate Charge (V <sub>GS</sub> = -10V)             | Qg                  |     | 19.6  | _    |   |   |
| Total Gate Charge (VGS = -4.5V)                        | Qg                  | _   | 9.2   | _    | 20  | 45)/ 1 054                                  |
| Gate-Source Charge                                     | Qgs                 |     | 4.3   | _    | nC  | $V_{DS} = -15V, I_{D} = -9.5A$              |
| Gate-Drain Charge                                      | Qgd                 | _   | 3.9   | _    |   |   |
| Turn-On Delay Time                                     | t <sub>D(on)</sub>  | _   | 5.3   | _    |   |   |
| Turn-On Rise Time                                      | t <sub>r</sub>      | _   | 23    | _    |   | $V_{DS} = -15V, V_{GS} = -10V,$             |
| Turn-Off Delay Time                                    | t <sub>D(off)</sub> |     | 34    | _    | ns  | $R_G = 6\Omega$ , $I_D = -9.5A$             |
| Turn-Off Fall Time                                     | tf                  | _   | 26    | _    |   |   |
| Reverse Recovery Time                                  | t <sub>rr</sub>     | _   | 10    | _    | ns  |   |
| Reverse Recovery Charge                                | Qrr                 | _   | 3.3   | _    | $\frac{1}{1}$ IF = -9.5A, di/dt = 100A/µs |   |

5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

DMP3026SFDE

Document number: DS38679 Rev. 2 - 2

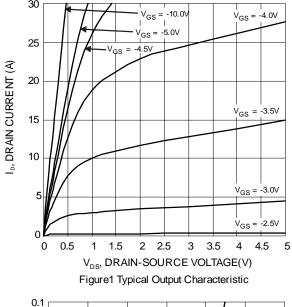
<sup>6.</sup> Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

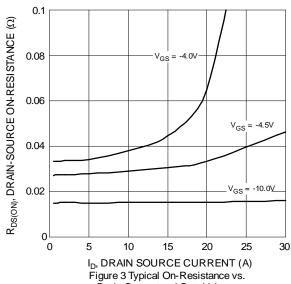
<sup>7.</sup>  $I_{AS}$  and  $E_{AS}$  rating are based on low frequency and duty cycles to keep  $T_J = +25$ °C.

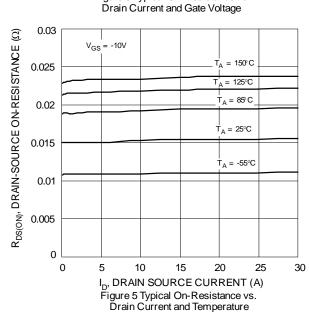
<sup>8.</sup> Short duration pulse test used to minimize self-heating effect.

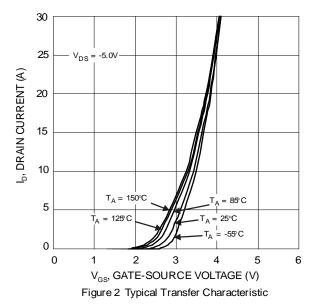
<sup>9.</sup> Guaranteed by design. Not subject to product testing.

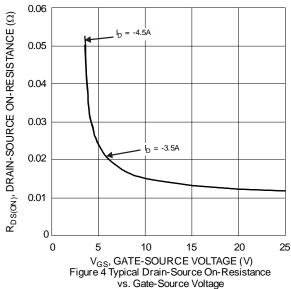


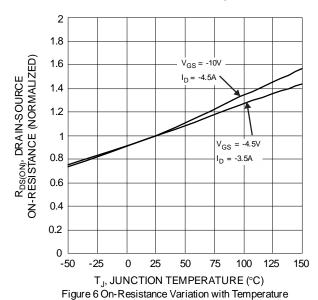




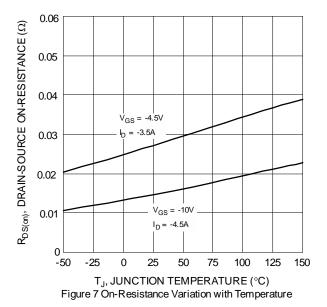


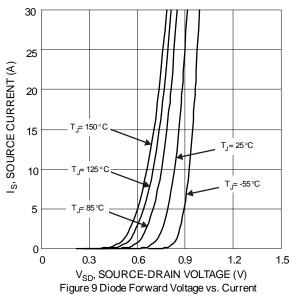


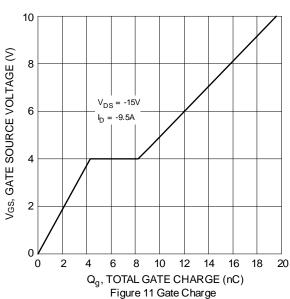












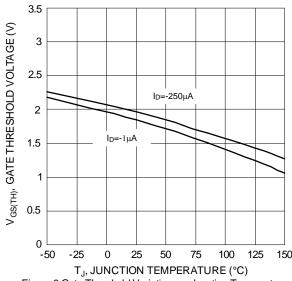
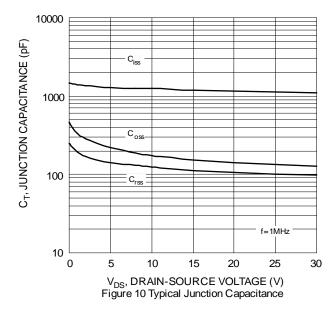


Figure 8 Gate Threshold Variation vs. Junction Temperature



100

R<sub>DS(on)</sub>

1 DC

P<sub>W</sub> = 100µs

P<sub>W</sub> = 1



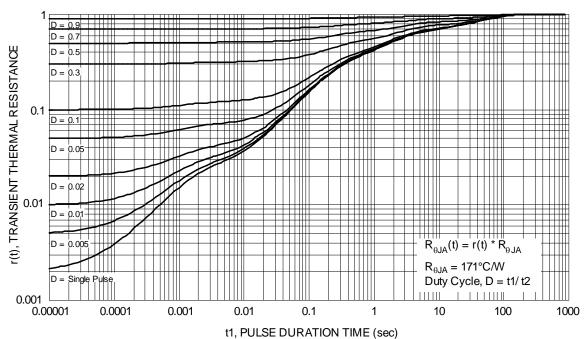


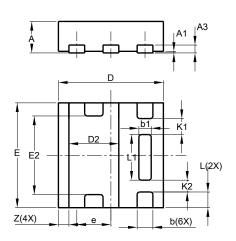
Figure 13 Transient Thermal Resistance



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### U-DFN2020-6 (Type E)

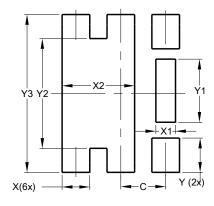


|     | U-DFN2020-6 |         |       |  |  |  |  |  |
|-----|-------------|---------|-------|--|--|--|--|--|
|     | Ty          | /pe E   |       |  |  |  |  |  |
| Dim | Min         | Max     | Тур   |  |  |  |  |  |
| Α   | 0.57        | 0.63    | 0.60  |  |  |  |  |  |
| A1  | 0           | 0.05    | 0.03  |  |  |  |  |  |
| A3  | -           | -       | 0.15  |  |  |  |  |  |
| b   | 0.25        | 0.35    | 0.30  |  |  |  |  |  |
| b1  | 0.185       | 0.285   | 0.235 |  |  |  |  |  |
| D   | 1.95        | 2.05    | 2.00  |  |  |  |  |  |
| D2  | 0.85        | 1.05    | 0.95  |  |  |  |  |  |
| Е   | 1.95        | 2.05    | 2.00  |  |  |  |  |  |
| E2  | 1.40        | 1.60    | 1.50  |  |  |  |  |  |
| е   | 1           | -       | 0.65  |  |  |  |  |  |
| L   | 0.25        | 0.35    | 0.30  |  |  |  |  |  |
| L1  | 0.82        | 0.92    | 0.87  |  |  |  |  |  |
| K1  | -           | _       | 0.305 |  |  |  |  |  |
| K2  | _           | _       | 0.225 |  |  |  |  |  |
| Z   | -           | _       | 0.20  |  |  |  |  |  |
| All | Dimen       | sions i | in mm |  |  |  |  |  |

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### U-DFN2020-6 (Type E)



| Dimensions | Value<br>(in mm) |
|------------|------------------|
| С          | 0.650            |
| Х          | 0.400            |
| X1         | 0.285            |
| X2         | 1.050            |
| Υ          | 0.500            |
| Y1         | 0.920            |
| Y2         | 1.600            |
| Y3         | 2.300            |



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